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INDUSTRY STANDARD OF THE PEOPLE'S REPUBLIC OF CHINA

SJ/T 11200-1999

Environmental testing. Part 2: Tests Test Td: Solderability, resistance to dissolution of metallization and to soldering heat of Surface Mounting Devices

环境试验 第2部分：试验方法 试验Td：表面组装元器件的可焊性、金属化层耐熔蚀性和耐焊接热

(English Translation)

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